SP8K22

4V Drive Nch+Nch MOS FET SP8K22

Structure

Silicon N-channel MOS FET

Features

- 1) Built-in G-S Protection Diode.
- 2) Small surface Mount Package (SOP8).

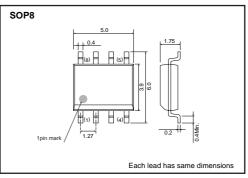
Applications

Power switching , DC / DC converter , Inverter

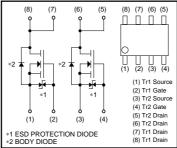
Packaging dimensions

	Package	Taping		
Туре	Code	TB		
	Basic ordering unit (pieces)	2500		
SP8K22		0		

•External dimensions (Unit : mm)



Equivalent circuit



A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

•Absolute maximum ratings (Ta=25°C) <It is the same ratings for the Tr1 and Tr2.>

Parameter		Symbol	Limits	Unit
Drain-source voltage		V _{DSS}	45	V
Gate-source voltage		V_{GSS}	20	V
Drain current	Continuous	I _D	±4.5	A
	Pulsed	I _{DP ∗1}	±18	А
Source current	Continuous	I _S	1	А
(Body diode)	Pulsed	I _{SP ∗1}	18	А
Total power dissipation		P _D ∗₂	2	W / TOTAL
		FD *2	1.4	W / ELEMENT
Chanel temperature		T_{ch}	150	°C
Range of Storage temperature		T _{stg}	-55 to +150	°C

*1 PW \leq 10 μs , Duty cycle \leq 1%

*2 Mounted on a ceramic board

Transistor

●Electrical characteristics (Ta=25°C)

< It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	10	μA	V _{GS} =20V, V _{DS} =0V
Drain-source breakdown voltage	V(BR) DSS	45	-	-	V	I _D = 1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	-	-	1	μA	V _{DS} = 45V, V _{GS} =0V
Gate threshold voltage	VGS (th)	1.0	-	2.5	V	Vps= 10V, Ip= 1mA
Static drain-source on-state resistance	R _{DS} (on)*	-	33	46	mΩ	ID= 4.5A, VGs= 10V
		-	41	57	mΩ	I _D = 4.5A, V _{GS} = 4.5V
		-	46	64	mΩ	I _D = 4.5A, V _{GS} = 4.0V
Forward transfer admittance	Y _{fs} *	3.5	-	-	S	V _{DS} = 10V, I _D = 4.5A
Input capacitance	Ciss	-	550	-	pF	V _{DS} = 10V
Output capacitance	Coss	-	140	-	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	70	-	pF	f=1MHz
Turn-on delay time	td (on) *	-	12	-	ns	V _{DD} ≒ 25V
Rise time	tr *	-	18	-	ns	$I_D = 2.5A$
Turn-off delay time	t _{d (off)} *	-	42	-	ns	VGs= 10V RL= 10Ω
Fall time	t _f *	-	12	-	ns	R _G =10Ω
Total gate charge	Qg *	-	6.8	9.6	nC	V _{DD} ≒25V, V _{GS} =5V
Gate-source charge	Q _{gs} *	-	2.0	-	nC	I _D = 4.5A
Gate-drain charge	Q _{gd} *	-	2.9	-	nC	$R_{L}=5.6\Omega, R_{G}=10\Omega$

*Pulsed

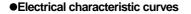
●Body diode characteristics (Source-drain) (Ta=25°C)

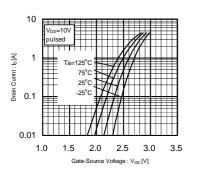
< It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	V _{SD} *	_	—	1.2	V	I _S =4.5A/V _{GS} =0V

* pulsed

Transistor







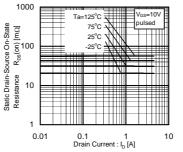


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current (1)

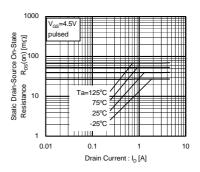
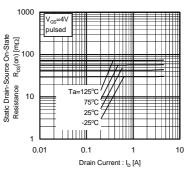


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (2)



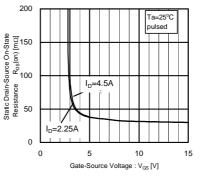


Fig.5 Static Drain-Source

On-State Resistance vs.

Gate-Source Voltage

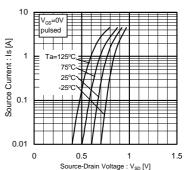


Fig.6 Source-Current vs. Source-Drain Voltage

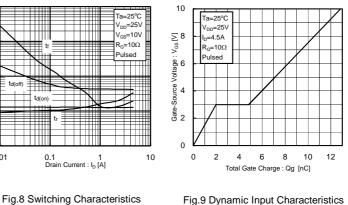
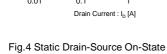
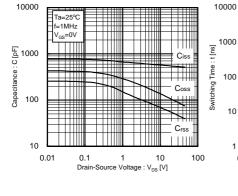
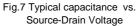


Fig.9 Dynamic Input Characteristics



Resistance vs. Drain Current (3)





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1

0.01

3/4

Transistor

Measurement circuits

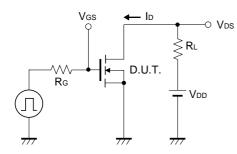


Fig.10 Switching Time Test Circuit

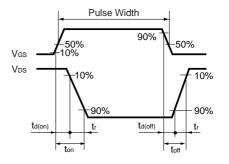


Fig.11 Switching Time Waveforms

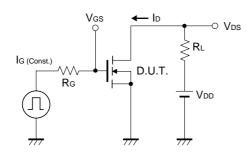
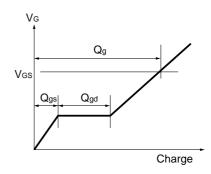


Fig.12 Gate Charge Test Circuit





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